consistent of:

Petassium dichromate Potassidm chlorida Hydrochlone acid, 5N

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for 15 seconds at 23°C. The strip was removed, rinsed with water and dried. There was no visible reaction with the protective metal stripe or wath the underlying silver film.

Example 2

A silver film on polyrethylene torephthalate) support was overcourted with nickel film in a pattern of stripes using the same process cessfriced in Example 1. The nickel was deposited in three thicknesses: 265 A. 130A and 53A. The samples were hathed in the treach solution of Example 1 as in Example 1 for 2 mintues at 23°C. nased in water and dried. In each case the improtected silver appeared to react uniformly with the solution while the silver underlying the nickel stripes showed no sign of reaction.

Disclosed anony mously (R1769) 15729

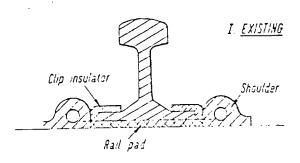
13702 Rad Pad

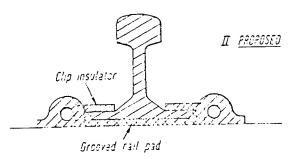
As shown in Figure 1, with existing rull fastening devices. As shown in Figure 1, with existing rail lastening devices, the roof the rull 2 rests on pads 3 and is clamped in position by spring clips (not shown) on each side of the rul 2. The rul 2 is insulated from the fastening device by rull clip insulators 4 which are located between the clip and the foot 1 of the rull 2, and are bent down at time edge so that they also fit and insulate between the edge 5 of the rull foot 1 and the fastening shoulder 6. Thus the function of the rull 3 is solely to support the rull 2.

A problem arises in locating the rail accurately in the fastening. The clin insulators have to be held in place while the rail is barred over and this has proved to be an awkward, time consuming and

msky operation.

By providing a pad 3 of channel section as shown in Figure 2, the pad 3 locates as well as supports the rail 2. Thus as indicated, the root 1 of the rail 2 is located between the walls 7 of the channelsection pad 3, with modified insulators 4 as shown.





Sketch showing sections through Pandrol rail fastening Snowing -I Existing type pad and clip insulator and II Proposed grooved pad and modified insulator (Not to scale)

Note Spring clips omitted from sketch

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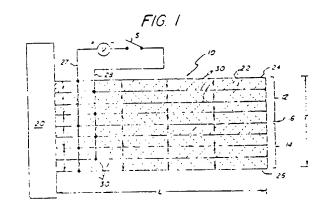
Multilayered piezoelectric flexi 🐉 device

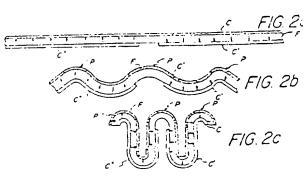
Disclosed herein are dexurally responsive piezo-electric devices of the unimorph and bimorph varieties. The piezo-electric component (x) of such devices is a multi-layered structure comprising a plurality of layers of a plastic piezoelectric film preferably polyvinylidene fluoride such layers being separated by conductive layers which serve as electrodes by which in electric field can be impressed across each film layer to cause a flexure action in the device.

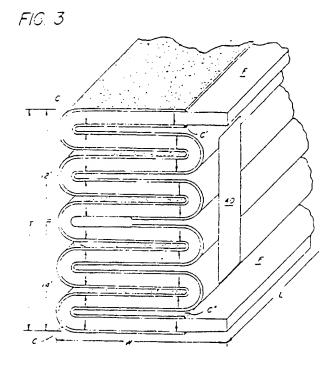
Detailed description of preferred embodiments

Referring now to the drawings. Fig. I is a cross-sectional view of a flexurally responsive piezoelectric device 10 of the bimorph variety. It comprises a pair of elongated, cantiliver-mounted, piezoelectric members, 12, 14 which are bonded together along an interface to to form a sand wich-like structure of length L, thickness T, width Wisse Fig 3). Note, the drawings are not drawn to scale inasmuch as the length-to-thickness ratio is not shown in proper proportion, typically, this ratio is between 10 and 1,000. In the drawings, the thickness dimension has been enlarged to better show the structure ceach of the piezoelectric members 12, 14.

As indicated above, piezoelectric members 12, 14 extend outwardly, in a funtilever fashion, from a rigid support 20, one end of wardly, in a funtilever fashion, from a rigid support 20, one end of each of the members being rigidly clamped to the support. Each of the piezoelectric members comprises a plurality of layers 22 of a high polymer film, preferably polyvinylidene fluoride (PVFs), which have been suitably poled to render them piezoelectric. The poling operation generally involves heating the film to an elevated temperature and subjecting it to an electric field for some minimum period of time. While processed in this manner, the electric dipoles in the film become aligned with the electric field lines, such field being applied across the thickness dimension of the film. The dipoles reapplied across the thickness dimension of the film. The dipoles re main in this orientation after the electric field has been removed and the film has returned to ambient temperature. As regards PVFs, the the film has returned to ambient temperature. As regards PVFs, the poling operation involves heating the material to approximately 100°s and applying a field of approximately 3 x 10° volts, cm for a period of about 1 hour. For further details on the poling procedure for PVFs, reference is made to the disclosures of US Patent No 3.894 19°s and British Patent No 1.349.860. Thin films of PVFs which have been surably poled to render them pizzoelectric are commercially available from Kurelia Chemical Industry, Co., Ed. in Tokyo, Japan. In Fig. 1, it will be noted that adjacent films layers 22 of each piezoelectric member 12 and 14 happen to be poled in opposite direction the poling direction being indicated by the arrows. This difference in the poling direction of adjacent layers inherently results from the the poling direction of adjacent layers inherently results from the particular process used to form the layers, as described hereinbelow. Further, at interface 16, it can be seen that the bottominost film layer of member 12 is poled in the same direction as the top-most







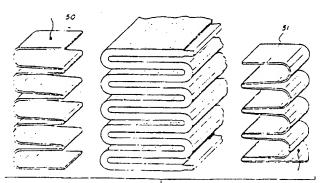


FIG. 4

Elim layer of member 14. The reason for this will become apparent from the ensuing further description.

Positioned between adjacent piezoelectric layers of each of the members 12, 14, is well as on the top and bottom surfaces 14 and 26 of the device, are electrically conductive layers 30. These conductive layers are resolved to the device of the probability of the device. agents are related to successful to the supplied across each layer. As shown in Fig. 1, alternate conductive layers are electrically connected together by leads 27, 28 so that when a voltage is applied to these leads from a voltage source V, an electric field is expliced across each pieceoelectric layer. Note, the direction of the electric field lines, (ie from * to -) across each of the piecoelectric layers comprising member 12 is in the polong direction of the piecoelectric layer. Thus, when switch S is closed and the electric field is 477 and all of the individual piecoelectric layers of member 12 will expand in length. As regards member 14, the direction of the As regards member 14, the direction of the action of the policy direction of each of the pickoelectric layers comprising member 14. Thus, when switch 5 is thosed pickoelectric member 14 will contract in length. The excession of the multilayered member 12, coupled with the contraction of the multilayered member 14, causes the pickoelectric device to flex or hind. It should be understood that ell of the tryers 22 and 30 of rach of the piezoelectric members 12 and 14 are honded together by

section fithe precoelectric members 12 and 14 are bonded together by an 20 rosive, such as Eastman 900 cement, available from Fastman 8,700 Company, Rochester, New York.

Each of the precoelectric layers 22 comprises a nine micron fite 250 of 0.50 x 10.3 inch thick tilm of PVFs. The apposing planus services of each PVFs fitm layer is couted such as by vacuum consistion or splittering techniques, with a thir layer of alluminum, so, 10.3 microns he 3 x 10.3 inch in thickness such courings serving 25 for conductive layers 30. Such metallized PVFs fitms can also be obtained from Kurcha Chemical fadinistry Co. 1 tol. As indicated abov. of the had from Kutaha Chemical Industry Co. Ltd. As indicated above. max mum dimensional changes in a PVF; film can be achieved by

applying a field of approximately 4 x 10 \$ oits/meter of thickness. For a nine micron thick layer, this translates to a voltage requirement of only about 360 voits. Thus, though the overall thickness of each of the multilayered piezoelectric elements 12 and 14 as shown in Fig.1 is about 36 microns (e. 4 layers x 9 microns per layer) maximum dimensional changes in such a member can be achieved by applying a soltage of only 1.4 the soltage which would be required to produce maximum dimensional changes in a single layer which is 36 microns thick. Further, by designing each of the piezoelectric members of a bimorph as a multilayered structure, a substantial increase in the beam strength and, hence, driving force is achieved. It will be understood, of course, that each piezoelectric member 12, 14 may comprise substantially more layers than shown in the drawing. In fact, each member may comprise 30 or more layers of film.

In order to assemble a flexure device of the type described above, one surface of a relatively large sheet of PVF, film F is coated with an electrically conductive material C. (See Fig 2a). The opposite surface is similarly coated with a conductive material and a small strip at the center is uncoared to provide two spaced electrodes C and C", each covering slightly less than one-half the surface area of the lower surface of film F. Electrodes C' and C" are positioned juxtaposed relative to the continuous electrode C. The PVF; film is poled by grounding electrode C and applying suitable voltages of opposite polarities to electrodes C and C". This results in poling one-half of the film sheet in one direction and the other half of the sheet in the opposite direction as indicated by the arrows. The sheet is then folded in a zig-zag fashion, as shown in Figs 2b and 2c, to form a plurality of pleats P. As a result of this folding operation, the PVFs sheet takes the form best illustrated in Fig 3. It will be noted that, as a result of this folding operation, adjacent layers of each of the elongated piezoelectric strips 12° and 14° appear to be poled in op-C and C', or between C and C'. the film positioned therebetween electrodes C and C', or between C and C'. the film positioned therebetween will either expand or contact, depending upon the poling direction.

To maintain the folded layers contiguous after the folding

operation, a hot-melt adhesive, such as manufactured by Black and Decker, is applied to the electrodes C, C' and C' prior to the folding operation. A conductive paint strip 40 is applied to both sides of the folded, multilayer structure to assure that electrical continuity is maintained after the folding operation. To produce the flexure action from the piezoelectric device so produced, one of the painted conductive strips is grounded while an electric field is applied to the other. This results in a undirectional field across all of the PVF: layers. Since hulf of the layers are poled in the same direction as the applied field, and half are poled in the opposite direction, one half of the piezoelectric layers will expand and the remaining half will contract, the result being the flexure action. Rather than form the bimorph structure from one continous

sheet of PVF: film, one may, of course, propare each of the multi-layered piezoelectric members 12 and 14 separately, and then bond maybeed perconsecute inferences 12 and 14 separately, and then condition to such bonding, however, the multilayered members must be oricited with respect to each other so that they react in opposite senses in response to the same applied field.

In Fig. 4, there is shown a pair of electrode structures 50 and 51

In Fig. 4, there is shown a pair of electrode structures 50 and 51 which are designed to make contact with the folded electrodes C. C. and C. after the folding operation. In operation, voltage source V is applied to these electrode structures.

Various types of adhesive have been found useful for bonding adjacent layers rogether. Hot melt give has been found to be the easiest to control and work with. This give is dissolved in solvene and applied to the services of electrodes C. C. and C.". After applying the hot melt give to the electrodes, allowing it to dry, and folding the film in a rigizing manner to form the multilayered structure shown in Figs. 1c, 3 and 4, the multilayered structure is prossed together and placed in a warm oven to melt the the part pressed together and placed in a warm oven to melt the glue and achieve the bonding effect. The effect of the bonding layers on the deflection-handwidth product of the bimorph has been found to be

It will be appreciated that the method disclosed above can also be used in the manufacture of unimorph devices. In the unimorph flexure device, only one of the members 12, 14 in Fig 1 exhibits precoelectric properties. Thus, in an electric field, the precoelectric member will expand or contract, depending on the poling direction, and the other member, which is bonded to the piezoelectric member, will remain unaffected. The result is the flexure action. Obviously, the piezoelectric member of the unintorph may comprise the multiple acres to proceed the properties of the properties that are the procedure of the procedure to the procedure of the unintorph may comprise the multiple acres to procedure the procedure of the the multilayered piezoelectric plastic film structure disclosed herein with reference to the himorph type device, and the same manufacturing process can be used to make it.

Disclosed by J Kelly Lee & Michael W Csontos

Poussoir pour montre électronique

and a second sec

Dans ce type de montres électroniques extra-plates, la liaison électrique

EMMUPEAN PATENT UPFILE

Patent Abstracts of Japan

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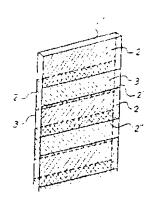
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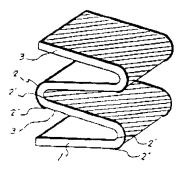
B28B 1/30 H01G 4/12 H01L 41/08

TITLE

MANUFACTURE OF CERAMIC

LAMINATE





ABSTRACT: PURPOSE: To facilitate manufacture of a thin, laminated ceramic device with inner and outer electrodes formed at a time by baking a laminate in the form of a pleat made of a ceramic green sheet which is provided with electrodes on both surfaces.

> CONSTITUTION: A green sheet is formed of an appropriate proportion of an organic binder, a plasticizer, and ceramic powder. One surface of the sheet is coated with electrode paste by spraying or screen printing, and dried. Similarly the other surface is also provided with electrodes. In this manner, a green sheet 1 with electrodes is prepared. The electrodes are preferably arranged in stripes at intervals narrower than the electrode width, and this arrangement is the same on both sides with some overlapping electrodes. This green sheet 1 is folded in such a manner that one end 2' of the electrode 2 is inside the fold and the other end 2" covers the outside of the fold completely. This makes it possible to easily make a thin laminate whose inner and outer electrode are simultaneously formed.

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⑩ 日本国特許庁(JP)

① 特許出願公開

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会発明の名称 積層セラミツクス製造法

②特 頤 昭62-255331

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写発 明 者 千 田 幸 雄 神奈川県横浜市緑区鴨志田町1000番地 三菱化成工業株式 会社総合研究所内

母発 明 者 西 村 哲 彦 神奈川県横浜市緑区鴨志田町1000番地 三菱化成工業株式

会社総合研究所内 会 明 者 小 栗 康 生 神奈川県横浜市緑区鴨志田町1000番地 三菱化成工業株式

母発明者小栗康生神奈川県横浜市緑区鴨志田町1000番地三菱化成工業株式会社総合研究所内

①出 類 人 三菱化成株式会社 東京都千代田区丸の内2丁目5番2号

愈代 理 人 弁理士 長谷川 一 外1名

明 細 書

/ 発明の名称

4

横層セラミックスの製造法

- - (1) シート状に成形されたセラミックスグリーン体を、該セラミックスグリーン体の両面に電極を形成した後ブリーツ状に折りたたむことによって積層体を形成し、該積層体を、焼成することを特徴とする積層セラミックスの製造法。
 - (2) 前記シート状に成形されたセラミックスグリーン体がセラミックス原料粉末、有機パインダー及び可塑剤を含有して成形されたものであることを特徴とする特許請求の範囲第(1) 項記載の積層セラミックスの製造法。
 - (3) 前記シート状に成形されたセラミックスグリーン体をブリーツ状に折りたたむ際に紙折機を用いることを特徴とする特許請求の範囲第(1)項及び第(2)項記載の積層セラミックスの製造法。

- (4) 前記シート状に成形されたセラミックスグリーン体を、ブリーッ状に折りたたむ際に折り目を50~150℃に加勢しながら形成させて折りたたむことを特徴とする特許請求の範囲第(1)~(3)項記載の積層セラミックスの製造法。
- 3 発明の詳細な説明

(産業上の利用分野)

本発明は順層セラミック圧電アクチュエータ、 積増セラミックコンデンサなどの積層セラミッ クスの製造法に関する。

(従来の技術)

電極材料をスクリーン印刷法などにより印刷し、その後所定枚数機層し、熱プレスにより一体化し、所定寸法に切断後、焼成を行なっている。各層を並列に電気的接続を行なりために前記の方法のいずれの場合にも最終工程として外部電極により内部電極を一層かきにプラス極とマイナス極となるように接続している。

外部電響により内部電響を並列に接続するには次の2つの方法が一般的にとられている。

製造法を提供するととにある。 (問題を解決するための手段)

本発明の目的は機圏セラミック圧電アクチュ エータあるいは積層セラミックコンデンサーな

ミックコンデンサーなどの積層セラミックスの

せ、素子端面には各層全ての内部は極の端部が露出するように配置し、この後あらたに一層おきに露出している内部電極の端部を絶像体/ 4 によって絶縁し、魏された一層おきの露出している内部電極の端部を外部電極/ 2 により接続する方法である。

(発明が解決しようとしている問題点)

内部電極を並列的に接続する方法は前記いずれの場合も、内部電極形成とは別を工程で行ない、さらに / 層かきに内部電優を接続させなければならないので、高い精度と、複雑な工程が必要である。との問題は等に、セラミックスの一層がさらに薄くなるほど、また、積層数が増加するほど顕著となる。

例をは、一層かきに内部電極の機能を露出させ、露出していない部分を絶縁部としているタイプ(第1の方法)では、この絶縁部分は圧配 アクチュエータ、コンデンサーにとっては、 絶縁を保つという以外はその性能に対してなんら 寄与していないのでこの部分は出来るだけ小さ

どの積溜セラミックスを、従来法の難点を克服して工業的有利に製造することにあり、しかしてかるる本発明の目的はシート状に成形された、セラミックスグリーン体を、その両面に電極を形成した後ブリーツ状に折りたたむことによって積層体を形成し、その積層体を携成することによって容易に達成される。

以下本発明を詳細に説明する。

本発明に用いるセラミックス原料としては、 圧電体として

Pb(ZrTi)0; (PZT)
(PbLa)(ZrTi)0; (PLZT)

あるいは

PZT-Pb(Mg1/3 Nb2/3)03 などがあり、また誘電体としては

Ba Ti O 3

Sr T103

などが挙げられる。またその製造法は通常の方法例をは、原料酸化物を混合して仮発し、さらに砂砕したもの、あるいは共优法によって得ら

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れる粉末などが代表的に挙げられる。

粒径としては通常数 μπ 程度の大きさのもの が用いられる。より薄いシート状セラミックス グリーン体(以下、単にグリーンシートと称す る。)を得るためには用いる粒子も厚さに応じ て小さくする必要があるが、ドクタープレード 法でシート成形を行なり場合は通常 0.5~1 μm 程度の粒径の粉末を用いることが好ましい。ま たグリーンシートを得る為に用いる有機パイン メーは非水溶剤系を用いる場合はポリビニルブ チラール、ポリメチルメタアクリレート、メタ クリル酸エステル共重合体などであり、水系の 密制を用いる場合にはポリピニルアルコールメ チルセルロース、ヒドロキシエチルセルロース、 アクリル系ポリマーなどが代表的である。また 同じく可塑剤としてはジプチルフタレート、プ チルベンジルフタレート、ポリエチレングリコ ール、クリセリンなどが代表的である。シート **成形は例えばドクタープレード法を用いるなら** は、前記セラミックス原料粉末、有機パインダ

一、可塑剤とともに適宜分散剤を加え、有機パインダー、可塑剤、分散剤を容解する啓剤例えばエチルセロソルブ、トルエン、キシレン、ロープタノール、イソブロパノールあるいは水などとともにポールミルで/5~/00hr 混合し、スラリー状態にした後、脱泡を行ない、ポリエステルフィルム上にキャスティングし、乾燥後、ポリエステルフィルムから剝離することによりグリーンシートを得る。

有機パインダー、可塑剤、セラミックス原科 粉末の適切な量は、後の工程でグリーンシート を折りたたむ時に曲げられた部分にクラックが 人ったりあるいは切断されないように選択すべ きであり、具体的には通常、

有機パインダーが s~15 wt多、

可塑剤が 2~ / 』 ** t * 5、 残部がセラミックス原料粉末となる範囲から選択される。これら有機パインダーと可塑剤の最か、下限量より少ない場合は折り曲げ時クラックが発生しやすかったり、更には切断されてし

まうことのおこる可能性があり、また上限値よ り多い場合はセラミックス原料粉末が少なすぎ るために焼成後吸密な焼結体を得にくい傾向を 生ずる。特に可塑剤が多い場合はグリーンシー トが軟くなりすぎ、ハンドリングが困難となる。 次にグリーンシートの両面に電極を形成する には、前記得られたグリーンシートの片面にス ブレー法、スクリーン印刷法などにより電極べ ーストを瑜付し乾燥させた後に幾りの片面に同 様な方法で、電徳を形成する。あるいは、ポリ エステルフィルム上にあらかじめ進極材料をス プレー法、スクリーン印刷法により強布し、乾 染させた後に、ドクタープレード法によりセラ ミックス原料粉末を含むスラリーをこの上に、 キャスティングし、乾燥後、最上面にやはり同 **様を方法によりもり/つの電極層を形成し乾燥** する。さらに最終的にポリエステルフィルムを 剝難して、両面に電極層が形成されたグリーン

また両面に形成する電盔は、全面に電極を形

シートを得ることも出来る。

成させても、所定のパターンに従って部分的に 形成させてもよい。

用いる電気材料としては Pt あるいは Ag - P4、Pt - Pd、 Pd、 Ag などを強付方法に従い適宜有機パインダー、溶剤などとともに混合、分散させたものを用いる。

費智方法は、両面に電極が形成されたグリーンシートを所定の幅、長さに切断後、例えば、所機などを用いてブリーン状に折りたたむ。この時折りたたみを容易に行なりために、あらかにめ折り目を形成させることが好ましいが温度の低い状態で折り曲げる、あるいは折り目をつけると、クラックが入るので、折り曲げ部分を加熱しながら行なりことがクラック防止に有効である。

以上の電観形成、折りた 3 み方の一例を図面に基づいて説明すると第 / 図は電極付グリーンシートの一例を示した説明図、第 2 図は該グリーンシートの折りた 3 み方の一例を示した説明図、第 3 図は折りた 3 みの前にグリーンシート

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に折り目をつける折り目形成装置の一例を示した 破断面模式図であり、各図中/は電極付きグリーンシート、よはグリーンシートに形成された電極部分、まはグリーンシートの非電極部分、 は折り目形成装置の一対のロール、まはその 実起部、4は同じくその陥役部をそれぞれ示す。

燥部分も少くなり、業子の性能に寄与しない部分を最少限に少く出来ることとなる。

得られた積層セラミックスは圧電体であれば 分極処理を行ないリード線の半田づけを行なり。 以下、実施例によって、本発明を更に具体的 に説明するが、本発明はその要旨を越えない限 り、下記実施例によって限定されるものではな

次に、、プリーン状に所定の積をとなく、 がりたとまれたであり、とないである。 ましくは熱けてマンシートではないでは、以になりのいて、グリーンとも、 のいて、グリーンとの両面があれたといる。 は、内の、外部では、できれたでは、できないでは、できないでは、できれたでは、できれたでは、できないでは、できないでは、できないでは、はないでは、はないでは、 また、の従来積層は、できないでは、 分の大きさは各セラミック層の厚さは、ないで、 り、/ 値の厚さが薄くなればなるほど、この絶

 \sim °

く実施例/>

(1) クリーンシートの作製

セラミックス原料粉末として市販のチタン酸シルコン酸鉛60A(富士チタン工業株式会社製;平均粒径約1μm)60.19、有吸バインダーとしてポリビニルプチラールにヨー1(積水化学工英株式会社製)4.89、可塑剤としてジプチルフタレート2.89、分散剤1.79、溶剤としてエチルセロソルプ16.79をボールミルを用いて48時間混合した。得られたスラリーの粘度はブルックフィールド型粘度計を用いて3000cpa(12rpm、20°)であった。

このスラリーをポリエステルフィルム上にキャスティングし、ドクタープレード法によりシート成形を行なった。 乾燥後ポリエステルフィルムからハクリしてグリーンシートを得た。この時得られたシートの厚さは70 μm であった。

特開平1-97604(5)

電極の金付はスクリーン印刷法により、片面ずつ Pt ペーストを塗付した。用いたスクリーンは3 5 0 メッシュのステンレス製であった。また塗付した電極は、グリーンシートの全面にペタ塗りした。

(2) 横 傷

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(1)で得られた両面に電気が形成されたグリーンシートを腐す点、良さ/mの帯状に切断した後、第3回に示した様を折り目形成用の 台具を通し折り目をつけた。この時折り目と 折り目の間端は/2mmであった。また折り目 形成台具はあらかじめ80℃になるように加 温されている。

折り目のついたグリーンシートは容易に折りたたむことが出来るので折りたたんだ後に長さ5cm、幅1.2cm、深さ5cmの金型中に入れ、滅圧脱気下、80℃ 5時間 圧力5 by/cmで加熱圧着を行ない環境一体化した。

得られたグリーン状態の積層体は / 層 7 um 8 3 層で全体の大きさは長さ 5 cm、幅 1.2 cm、厚さ約0.6 cmであった。

(3) 焼 桔

上記グリーン状態の積層体をアルミナ質の 鉢中に始界囲気調製用にジルコン酸鉛を入 れ、アルミナ製のふたをしてよりのでまでは ノので/hrで昇退し、その後よりのででは時間保持した。次いでノよりで/hrで昇温し ノスよりでで/時間保持して焼結を行ない、 積層セラミック圧電体を得た。

<実施例2>

特公昭」5-3 4 5 2 4 号公報 実施例/で示される共先法にて得られた Pbo.91 Lao.09 (Zro.65 Tio.15) 0.9175 O1 粉末をセラミックス原料粉末として使用した以外は実施例/と同様にして、積着セラミック架子を製造した。

得られた積層セラミック素子は電気光学素子として、光シャッター等にも有用である。

折りたたみを紙折機(株式会社筑紫製 700 型)を用いて行なった以外は、実施例/と同様

にして行ない、積層体を製造した。

クリーンシートの画面に 形成 する 電極のバターンを 第 / 図に示すように 形成 折りた 3 み方を 第 2 図の如く行った以外は実施例 / と同様にして、各セラミックス層間に一層の 電極を有し、外部電優への接続が極めて容易なセラミックス 慣る体を 44 た。

(発明の効果)

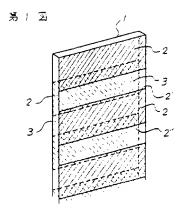
<実施例4>

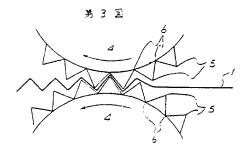
4 図面の簡単な説明

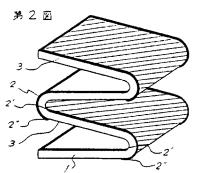
く実施例3>

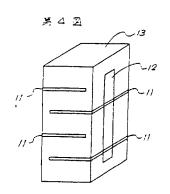
出 願 人 三菱化成工業株式会社 代 理 人 弁理士 長谷川 ー ほか/名

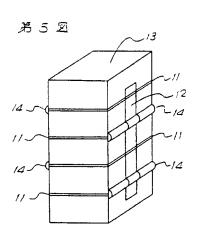
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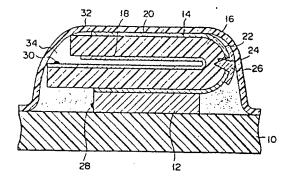
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- 71) Applicant: Kabushiki Kaisha Toshiba 72, Horikawa-cho Saiwai-ku Kawasaki-shi Kanagawa-ken 210(JP)
- 12) Inventor: Kaneko, Nagao c/o Patent Division Kabushiki Kaisha Toshiba 1-1, Shibaura 1-chome Minato-ku Tokyo 105(JP)
- (72) Inventor: Nakamura, Nanao c/o Patent Division Kabushiki Kaisha Toshiba 1-1, Shibaura 1-chome Minato-ku Tokyo 105(JP)
- Representative: Henkel, Feiler, Hänzel & Partner Möhlstrasse 37 D-8000 München 80(DE)

(54) Ultrasonic transducer with a multiple-folded piezoelectric polymer film.

(57) An ultrasonic transducer includes a piezoelectric polymer film (14) folded as at least two layers and having electrodes on both the surfaces thereof. The ultrasonic transducer is responsive to a signal, applied across electrodes, to produce an ultrasonic wave to be focused at one spot so that it is converted to an electric signal. In this ultrasonic transducer, a groove (24) or through holes (42) are formed on and along the folded area (22) of the piezoelectric polymer film.

F1G. 3



Ultrasonic transducer with a multiple-folded piezoelectric polymer film

This invention relates to an ultrasonic transducer with a multiple-folded piezoelectric polymer film.

In general, as a linear array type ultrasonic transducer for use on a linear electron scanning system use may be made of an array type in which a ceramics piezoelectric substratum, such as lead titanate or lead titanate zirconate, includes strip-like elements. type of ceramics piezoelectric substratum is hard and brittle in nature and tends to produce defects and cracks when the strip-like elements are obtained. Furthermore, it is difficult to precisely form many strip-like elements. Many problems are also involved from the standpoint of manufacturing costs.

It is known that a fluorine-containing high polymer, such as polyvinylidene fluoride (PVF_2) or polyvinylidene-triethylene fluoride copolymer (PVF2 • TrFE), or the other organic synthetic high polymer is polarized at high temperatures under a high electric field to manifest its piezoelectricity and pyroelectricity. Recently, an ultrasonic transducer has actively been developed utilizing the thickness shear mode of the piezoelectric high polymer. specific acoustic impedance of this piezoelectric polymer is close to that of a human body and, moreover, a smaller elasticity is involved on the piezoelectric 25

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polymer. It is said that, if the piezoelectric polymer is applied to a linear array type ultrasonic transducer, it is unnecessary, unlike the ceramics piezoelectric substratum, to obtain strip-like elements by a cutting operation or a separating operation.

The dielectric constant of the piezoelectric polymer film is, in general, of the order of 10, i.e., prominently smaller than that of the ceramics piezoelectric substratum. Furthermore, the drive elements of the linear array type ultrasonic transducer have a smaller area and an extremely high acoustic impedance. Usually, a poor matching is involved against a 50 Ω power source (transmitting/receiving circuit), suffering an appreciable loss on the ultrasonic transducer.

In order to solve the above-mentioned problems, an ultrasonic transducer has been proposed in which a plurality of piezoelectric polymer films are properly piled up to obtain a thicker polymer film while at the same time the electric impedance is lowered. of conventional ultrasonic transducer is shown in Fig. 1. In the conventional ultrasonic transducer, a plurality of piezoelectric polymer films (3, 3, 3), each, have strip-like electrodes 1 on one surface and a common electrode 2 on the other surface and are piled up such that the two adjacent piezoelectric polymer films have their identical electrodes located opposite to each other as shown in Fig. 1. The opposite, identical electrodes of the adjacent two polymer films are connected by a solder or a conductive adhesive 4 to each other. For example, the strip-like electrode 1 of the first piezoelectric polymer film is located opposite to the strip-like electrode 1 of the corresponding adjacent second piezoelectric polymer film. Such a type of ultrasonic transducer is known which lowers an electric impedance. With Zo representing an electric impedance of, for example, a single layer of a resonant frequency f,

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 $Z = Zo/n^2$ (n: the number of layers) for the ultrasonic transducer of the configuration as shown in Fig. 1. An electric impedance of 1/4 is involved for a two-layer structure and an electric impedance of 1/9 is involved for a three-layer structure. It is, therefore, possible to obtain an improved matching with respect to a power source. In the conventional arrangement as shown in Fig. 1 it would be difficult to take leads 5a and 5b out of the electrodes 1 and 2, respectively.

An ultrasonic transducer of such a type as shown in Fig. 2 has also been proposed which has a continuous, piezoelectric polymer film 3a properly folded as a multiple-layer structure of a desired thickness. In this transducer, it is easier to take leads from the corresponding electrodes and it is also possible to lower the electric impedance. However, the following problems arise therefrom.

That is, if a continuous, piezoelectric polymer film is to be folded, it would be difficult to precisely locate the corresponding areas of the strip-like electrodes opposite to each other. In this case, a possible displacement is produced in the vertical directions of the electrodes 1, causing a difference in the electric impedance of drive elements and producing a possible shorting between the drive elements. This problem becomes prominent with an increase in the number of layers so piled up.

It is accordingly an object of this invention to provide an ultrasonic transducer having a piezoelectric polymer film which is readily folded as a multiple-layer structure and which assures a ready, accurate alignment between the opposite areas of corresponding electrodes.

According to this invention there is provided an ultrasonic transducer including a piezoelectric polymer film having electrodes on both the surfaces thereof

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and folded as at least two layers, the piezoelectric polymer film being responsive to a signal applied to the electrodes to generate an ultrasonic wave focused on one spot and being adapted to receive an ultrasonic wave to convert it to an electric signal, in which a groove is formed along a folding line on the piezoelectric polymer film.

This invention will be explained below with reference to the accompanying drawings.

10 Figs. 1 and 2 are cross-sectional views showing a conventional ultrasonic transducer;

Fig. 3 is a diagrammatic, cross-sectional view showing an ultrasonic transducer according to a first embodiment of this invention;

Fig. 4 is a perspective view diagrammatically showing a state previous to that in which a piezo-electric element of the ultrasonic transducer as shown in Fig. 3 is folded;

Figs. 5 to 7 are cross-sectional views diagrammatically showing a modified form of piezoelectric film with respect to the ultrasonic transducer of this invention;

Fig. 8 is a cross-sectional view diagrammatically showing an ultrasonic transducer according to a second embodiment of this invention;

Fig. 9 is a perspective view diagrammatically showing a state previous to that in which a piezo-electric film of the ultrasonic transducer of Fig. 8 is folded; and

Figs. 10 and 11 are cross sectional views diagrammatically showing a piezoelectric film of a conventional ultrasonic transducer for use in explaining an advantage of the embodiment of this invention.

The embodiments of this invention will be explained below by referring to Figs. 3 to 11 of the accompanying drawings.

First, an ultrasonic transducer according to the

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embodiment of this invention will be explained below in more detail by referring to Figs. 3 to 7.

In Fig. 3, reference numeral 10 shows a support made of, for example, an acrylic resin. A copper plate 12 is fixed on the support 10 and serves as a 200 µm-thick sound reflecting plate and a common electrode. A once-folded piezoelectric film 14 is disposed on the copper plate 12 and has a PVF, piezoelectric element 16. A plurality of strip-like electrodes 18 made of silver are equidistantly provided on one surface of the piezoelectric element 16 and a common electrode 20, made of silver, is provided on the whole area of the other surface of the piezoelectric element 16. At the common electrode of the PVF2 piezoelectric element 16 a V-shaped groove 24 is formed on a substantially central portion of a folded area 22 of the piezoelectric element 16 such that it is located along the folding line, i.e., in a direction perpendicular to that in which the strip-like electrode 18 extends. The V-shaped groove 24 is formed across substantially one half of the thickness of the piezoelectric element with the common electrode 20 separated.

Fig. 4 is a perspective view showing a state before the piezoelectric film 14 is folded. The piezoelectric body as shown in Fig. 4 is folded back upon itself along the folding line with the V-shaped groove 24 located at the outer side as shown in Fig. 3.

The folded piezoelectric film 14 is disposed on the copper plate 12 such that the common electrode 20 is in contact with the copper plate 12.

The common electrode 20, though separated by the V-shaped groove 24 as set out above, has its separated areas mutually connected by, for example, a conductive paste 26 which is deposited at and near the V-shaped groove 24 as shown in Fig. 3. As the conductive paste use may be made of an epoxy resin mixed with carbon,

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copper or silver powders.

The folded piezoelectric film 14 is manufactured by the following method.

An about 1 µm-thick silver layer is deposited by, for example, a vacuum deposition method on both the 5 surfaces of an about 50 μm -thick PVF₂ film which is obtained by a uniaxial stretching method. The resultant structure is polarized under an electric field of 6 KV at 100°C for 1 hour and then cooled down to room 10 temperature to yield a PVF2 piezoelectric element 16. In this case, one surface of the PVF2 film is subjected to a patterning as shown in Fig. 4, forming a plurality of strip-like electrodes 18 in a manner to be in parallel with the direction in which uniaxial stretching 15 is carried out. As the strip-like electrodes, 64 unit electrode elements are formed having a dimension of about 0.9 mm in width x about 35 mm in length with an element-to-element gap of about 0.1 mm. The other surface of the PVF2 film is subjected to a patterning to form the common electrode 20 made of silver. A 20 V-shaped groove 24 of about 30 µm in depth x about 0.2 mm in width is formed by, for example, a cutter along a folding line. The resultant structure is folded back upon itself once along the V-shaped groove 24 to provide the above-mentioned PVF2 piezoelectric 25 film 14. Then, a conductive paste 26 is deposited at and near the V-shaped groove 24 and dried to provide a folded piezoelectric film 14 in which the common electrode areas separated by the V-shaped groove are 30 connected to each other. A lead 28 is connected to the copper plate 12 and a lead 30 is connected to the respective strip-like electrode 18 of the folded piezoelectric film 14 such that it is located at one end portion of the piezoelectric film 14 and on the inner 35 side of the folded piezoelectric film 14. A polyester film of, for example, 12 µm in thickness is covered on the resultant structure, noting that an epoxy resin 34

is filled in a space between the polyester film 32 and the piezoelectric structure. The epoxy resin 34 is commercially available under the trade name of 301-2 manufactured by Epotek Co., Ltd. The presence of the epoxy resin 34 positively retains the state in which the piezoelectric film 14 is folded back upon itself, and also assures a positive fixing of the piezoelectric film 14 to the support 10.

In the embodiment of this invention, a folding operation can readily been carried out, since the V-shaped groove 24 is formed on one surface, for example, on the common electrode side, of the PVF₂ piezoelectric structure to be folded back upon itself. This specific arrangement permits the upper portion of the folded piezoelectric structure to be accurately aligned with the lower portion thereof in a substantially parallel array. As a result, there is no possibility that the impedance of drive elements will vary due to a misalignment between the oppositely facing strip-like electrodes of the folded piezoelectric structure and that short-circuiting will occur between the drive elements. It is therefore possible to obtain a linear array type ultrasonic transducer of high reliability.

In actual practice, the linear array type ultrasonic transducer was measured, but no electric impedance variation was not observed across the unit electrode elements. When a pulse voltage was applied between the common electrode 20 and eight of the unit electrode elements, the ultrasonic transducer was operated at a frequency of 5 MHz.

The PVF_2 piezoelectric transducer may be formed in a multiple-folded fashion to obtain a linear array type ultrasonic transducer of a low electric impedance. Even in this case, it is possible to readily perform such a folding operation.

Furthermore, a V-shaped groove 24 is formed along

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each folding line, preventing the folded area from being extremely bulged.

It has been confirmed that, if the folded area of the conventional piezoelectric body as set out below is bulged as shown in Fig. 11, an electric loss or an "electric stroke" occurs on the bulged area, or an acoustic coupling, for example, occurs there, causing a disturbance of ultrasonic radiation beams.

In the embodiment of this invention it is possible to prevent such an electric loss or a possible disturbance of ultrasonic radiation beams, because there is no bulging area at the folded area of the piezoelectric film. It is therefore, possible to obtain an ultrasonic transducer assuring an excellent performance.

In the embodiment of this invention, the groove 24 is provided on one surface, for example, on the common electrode side, of the piezoelectric film 14 such that their separated areas of the common electrode are electrically connected through the conductive paste or metal film 26 deposited at or near the groove 24. However, this invention is not restricted thereto. For example, the metal film 26 for electrical connection may be provided, by a vapor deposition method or a sputtering method, on the V-shaped groove 24 at the folded area 22 of the piezoelectric film 14 as shown in Fig. 5.

As shown in Fig. 6, the piezoelectric film may be folded back upon itself with a V-shaped groove 24 internally formed along a folding line on the opposite, inner, common electrode 20 areas of the piezoelectric film. In this case, a conductive paste 26 may be deposited at the V-shaped groove 24 to permit the separated areas of the common electrode to be connected together.

Where the piezoelectric film 14 is folded back upon itself with the groove 24 inside, it is still possible to locate a conductive plate 38 at a proper place

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between the opposite, inner, common electrode areas to permit an electrical connection to be made therebetween.

The leads 28 and 30 may be connected at any place to the common electrode 20 and strip-like electrode 18, respectively. For example, the leads 28 and 29 may be connected to the corresponding electrodes, respectively, such that, as shown in Fig. 5, the lead 30 extends on the upper side of the electrode 20 and the lead 28 extends on the lower side of the electrode 18.

An ultrasonic transducer according to a second embodiment of this invention will be explained below by referring to Figs. 8 and 9. The same reference numerals are employed to designate parts or elements corresponding to those shown in the first embodiment of this invention. Further explanation is therefore omitted.

In the ultrasonic transducer according to a second embodiment, two folded areas 22, 22 are formed on a piezoelectric element 16 to provide a three-layer piezoelectric structure as shown in Fig. 8. Through holes 40, 42 are formed at the folded areas of the piezoelectric element in place of the V-shaped groove 24 set out above.

That is, the through holes are formed, in two rows, at those locations adjacent to strip-like electrodes 18 on a piezoelectric film 14 such that they are located in a directon perpendicular to that in which the strip-like electrodes 18 extend. The piezoelectric film 14 is folded, along the two rows (40, 42) of the through holes, with an adhesive layer 34A initially coated thereon, providing the piezoelectric film structure with the adhesive layer filled therein.

The piezoelectric film 14 is manufactured as follows:

First, an about 1 μm -thick silver layer is deposited by, for example, a vacuum deposition method on both the surfaces of an about 50 μm -thick PVF₂ film

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which is obtained by a uniaxial stretching step. The resultant structure is polarized under an electric field of 6 KV at 100°C for one hour and cooled down to room temperature to provide a PVF2 piezoelectric structure. In this case, a silver layer on one surface of the piezoelectric structure is subjected to a patterning as shown in Fig. 9 to provide strip-like electrodes 18 in a direction parallel to that in which uniaxial stretching is carried out. As the strip-like electrodes 18, 64 unit electrode elements are formed each having a dimension of 0.9 mm ir. width \times 45 mm in length with an element-to-element gap of 0.1 mm. silver layer on the other surface of the piezoelectric structure is subjected, as required, to a patterning to provide a common electrode 20. Then, small through holes (40, 42) of about 50 µm in diameter are formed, by a laser beam, in two rows on those fold formation areas 22 which are adjacent to the strip-like electrodes Then, the resultant PVF2 piezoelectric structure 14 is folded along two rows (40, 42) of the through holes to provide an S-shaped (three-layered) piezoelectric structure as shown in Fig. 8 with an epoxy resin series adhesive cemented by a press. The adhesive is commercially available under the trade name of 301-2 manufactured by Epotek Co., Ltd. A lead 28 is connected to a copper plate 12 and a lead 30 is connected to the respective strip-like electrode 18. A polyester film 32 of, for example, 12 μm in thickness is covered on the piezoelectric structure to provide a ultrasonic transducer as shown in Fig. 8 in which the adhesive (301-2) is occupied therein. In this connection it is to be noted that the piezoelectric structure is supported on a support 11.

According to the second embodiment of this invention, although the piezoelectric structure is folded along the two rows (40, 42), it is possible to obtain the same effects as shown in the first embodiment

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of this invention. Furthermore, it is not necessary to employ any co...d_ctive paste for electrical connection, because the respective electrodes are not electrically separated by the through holes (40, 42). The adhesive layer 34A is passed through the through holes (40, 42) of the piezoelectric film 14 to suppress the bulging of the folded area to a small extent. At the same time, any excessive amount of adhesive in the layer-to-layer gap can be removed to form a very uniform, thin adhesive layer 34A. When, therefore, the ultrasonic transducer is operated, it is possible to eliminate a possible acoustic coupling and "electric stroke" at those areas adjacent to the strip-like electrodes where no voltage is applied.

When a length of a piezoelectric polymer 3a is doubled back upon itself as shown in Figs. 10 and 11, a force acts in a direction as indicated by arrows B, causing the adhesive to be moved toward the folded area (i.e. in a direction as indicated by an arrow A) where it is concentrated to cause the folded area to be bulged as shown in Figs. 10 and 11.

In the ultrasonic transducer according to the second embodiment of this invention no bulging occurs, since no excessive amount of adhesive flows toward the folded area due to the presence of the holes 40, 42. Furthermore, when the PVF₂ piezoelectric film 14 is to be multiple-folded to provide a linear array type ultrasonic transducer of a low electric impedance, a folding operation can be readily effected along the through holes (40, 42).

According to this invention, since the through holes (40, 42) are formed on the folded area of the PVF₂ piezoelectric film 14, an extra amount of adhesive is passed out through the through holes (40, 42) during the folding/cementing step to obtain an integral unit. It is also possible to obtain a modified form of PVF₂ piezoelectric film which includes, for example, a

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continuous, vertical, multi-folded structure including concave layers.

According to this invention, the through holes, though formed by a laser beam on the PVF₂ piezoelectric film, may be formed by, for example, a melting method or a mechanical method on the PVF₂ piezoelectric film.

It is desirable for the through holes to be formed on the non-working areas between the respective strip-like electrodes as in the second embodiment. However, they are formed on the strip-like electrodes so far as the operation of the ultrasonic transducer is not affected by the configuration of the strip-like electrodes. The through holes may also be formed on the boundary area between the working and non-working areas if a narrow gap is defined between the strip-like electrodes.

This invention is not restricted to the abovementioned embodiments. Various changes or modifications
may be made without departing from the spirit and scope
of this invention.

For example, the piezoelectric film may be formed with four or more folding areas, instead of being formed with two or three folding areas.

According to the above-mentioned embodiments, as the PVF₂ piezoelectric body use is made of a piezoelectric material, but use may also be made of a fluorine-containing synthetic high polymer, such as TrFE, or the other organic high polymers showing the piezoelectricity, or a complex piezoelectric film prepared by mixing with a high polymer resin a ceramics type piezoelectric powder such as powdered lead titanate or lead titanate zirconate.

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Claims:

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- l. An ultrasonic transducer including a piezoelectric polymer film having electrodes on both the
 surfaces thereof and folded as at least two layers,
 said piezoelectric polymer film being responsive to a
 signal applied to the electrodes to generate an ultrasonic wave focused on one spot and being adapted to
 receive an ultrasonic wave to convert it to an electric
 signal, characterized in that a groove (24) is formed
 along a folding line on said piezoelectric polymer
 film (14).
- 2. The ultrasonic transducer according to claim 1, characterized in that said groove (24) on a folded area (22) of said piezoelectric polymer film is formed on a side on which an outside electrode of said electrodes is located.
 - 3. The ultrasonic transducer according to claim 1, characterized in that said groove (24) on a folded area (22) of said piezoelectric polymer film is formed on the side of said electrode (20).
 - 4. The ultrasonic transducer according to claim 1, characterized in that said groove (24) on a folded area (22) of said piezoelectric polymer film extends along said folding line to separate one of said electrodes into two areas, said two areas of said one electrode being electrically connected to each other through a conductive material (26).
- 5. The ultrasonic transducer according to

 claim 1, characterized in that said groove (24) on
 the folded area of said piezoelectric polymer film is
 V-shaped in cross section.
- 6. The ultrasonic transducer according to claim 4, characterized in that said conductive material (26) is covered on said groove on the folded area (22) of said piezoelectric polymer film, said conductive material being made of a conductive paste.

- 7. The ultrasonic transducer according to claim 4, characterized in that said conductive material is occupied as a hard conductive layer in a space between the opposite layers of said folded piezo-electric polymer film and serves as a spacer (38) and said electrode areas separated by said groove are electrically connected to each other through said spacer, said spacer supporting said piezoelectric polymer film in place to leave a substantially uniform layer of said conductive layer between the opposite layers of said folded piezoelectric polymer film.
- 8. An ultrasonic transducer including a piezoelectric polymer film (14) having electrodes on both the surfaces thereof and folded as at least two layers, said piezoelectric polymer film being responsive to a signal applied to the electrode to generate an ultrasonic wave focused on one spot and being adapted to receive said ultrasonic wave to convert it to an electric signal, characterized in that holes (40, 42) are formed along a corresponding folding line on said piezoelectric polymer film.
 - 9. The ultrasonic transducer according to claim 8, characterized in that said holes on the folded area (22) of said piezoelectric polymer film extend through said piezoelectric polymer film.
 - 10. The ultrasonic transducer according to claim 9, characterized in that said piezoelectric polymer film (14) has a common electrode (20) formed at the whole area of one surface of the film and strip-like electrodes equidistantly formed on the other surface of said film and said through holes (40) are formed at an area between said strip-like electrodes.

5

10

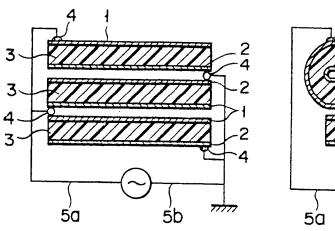
15

20

25

FIG. 1

FIG. 2



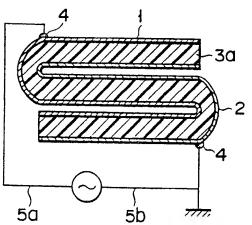
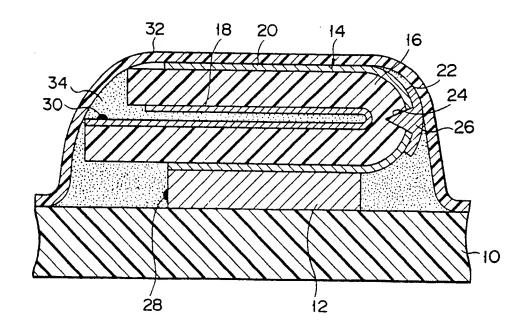


FIG. 3



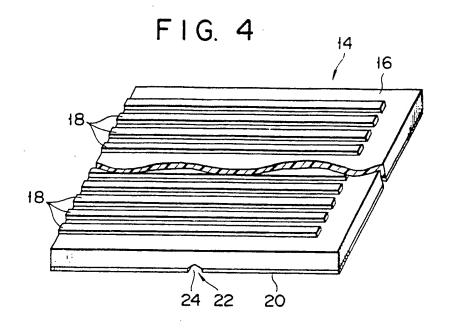


FIG. 5

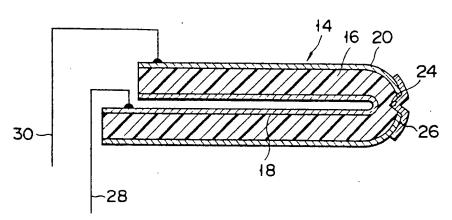


FIG. 6

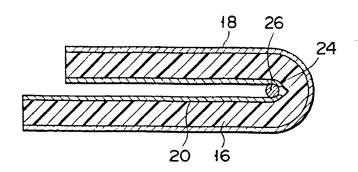


FIG. 7

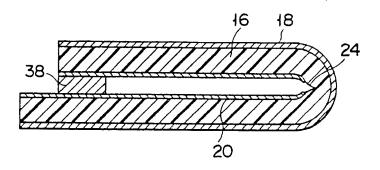
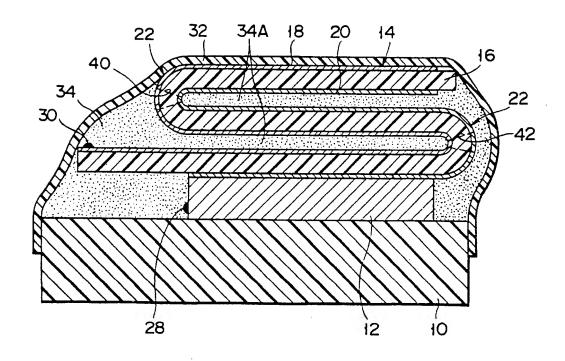
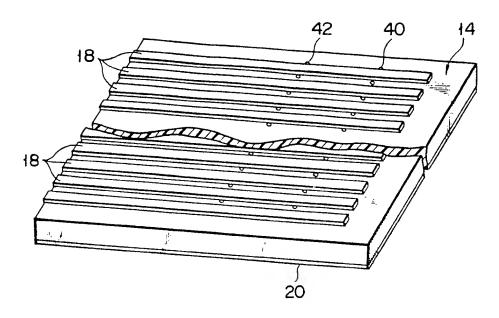


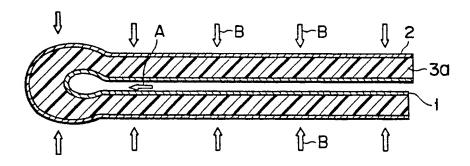
FIG. 8



F1G. 9



F1G. 10



F I G. 11

